



Sim. to ISO 62

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ISO 1183

# CELCON® M90-34

### **CELCON®**

Celcon® M90-34 is a specially formulated injection moldable grade of acetal copolymer for the appliance market targeted at resisting staining while providing a balance of properties.

Chemical abbreviation according to ISO 1043-1: POM

			4.5
Proc	luct i	inform	ation

Product information			
Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 11469
Continuous Service Temperature	104	°C	IEC 60216-1
Rheological properties			
Melt volume-flow rate	8	cm <sup>3</sup> /10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Moulding shrinkage, parallel	2.2	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	2550	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	63	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	11	%	ISO 527-1/-2
Flexural modulus	2450	MPa	ISO 178
Compressive stress at 1% strain	31	MPa	ISO 604
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C		kJ/m²	ISO 180/1A
Izod impact strength, 23°C		kJ/m²	ISO 180/1U
Poisson's ratio	0.38 <sup>[C]</sup>		
[C]: Calculated			
Thermal properties			
Melting temperature, 10 °C/min	165	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	100	°C	ISO 75-1/-2
Electrical properties			
Surface resistivity	1.3E16	Ohm	IEC 62631-3-2
Arc Resistance	240		UL 746B
Physical/Other properties			

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0.2 %

0.75 %

0.2 %

1410 kg/m<sup>3</sup>

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Humidity absorption, 2mm

Water absorption, Immersion 24h

Water absorption, 2mm

Density





#### **CELCON®**

### Injection

no	
100	°C
3 - 4	h
≤0.2	%
190	°C
180	°C
200	°C
≤0.3	m/s
100	°C
80	°C
120	°C
60 - 120	MPa
4	MPa
	100 3 - 4 ≤0.2 190 180 200 ≤0.3 100 80 120 60 - 120

#### Characteristics

Processing Injection Moulding

Delivery form Pellets

#### Additional information

Injection molding

### Preprocessing

Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

### **Processing**

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower

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than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

### Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

**Processing Notes** 

### **Pre-Drying**

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

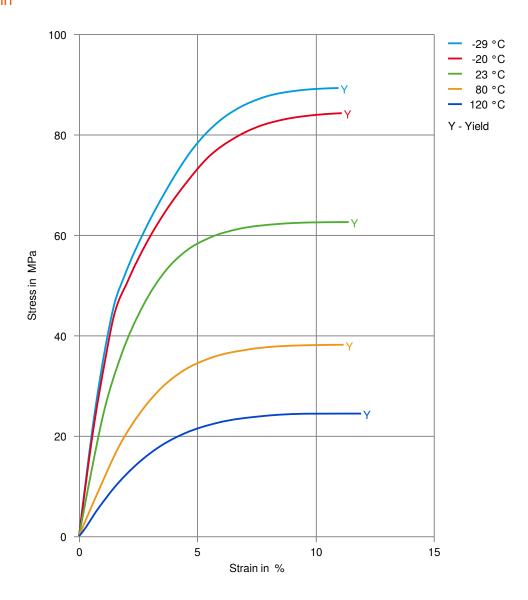
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### Stress-strain



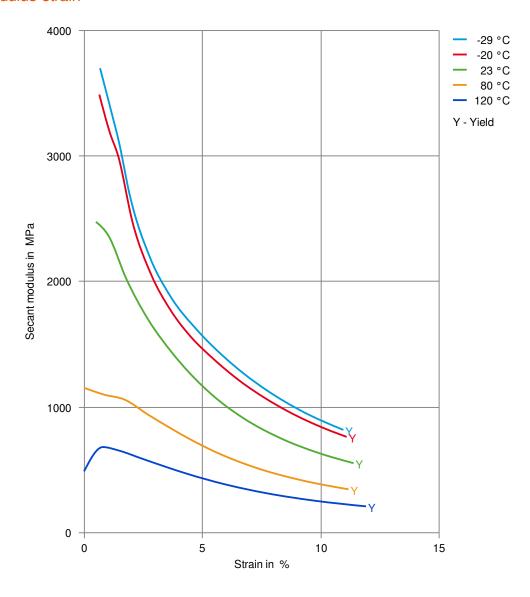
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### **CELCON®**

### Secant modulus-strain



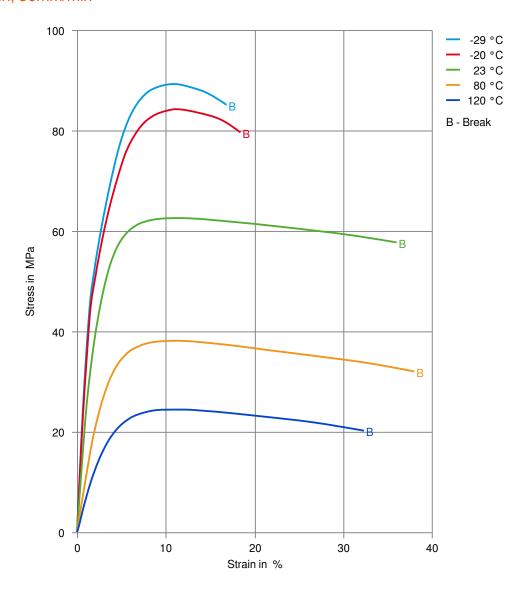
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Stress-strain, 50mm/min



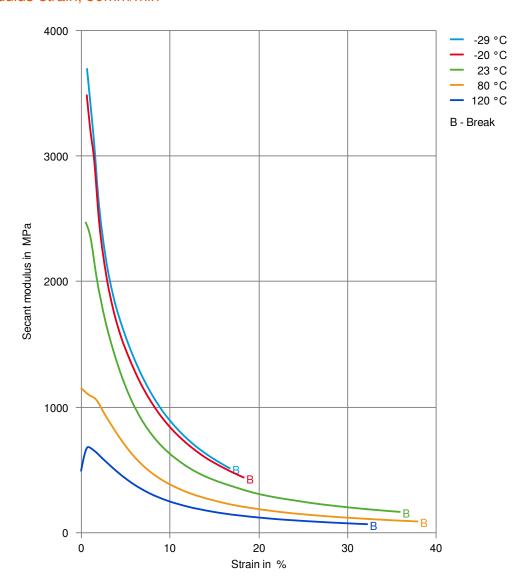
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### **CELCON®**

### Secant modulus-strain, 50mm/min



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NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any e

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